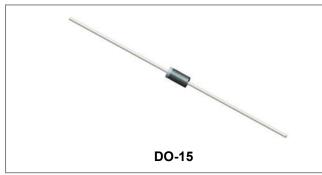






### SF21G-SF28G SUPER FAST RECTIFIER



#### **Features**

- · Super fast switching for high efficiency
- Low leakage current
- High forward surge capability
- Solder dip 260 ° C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

## **Circuit Diagram**



#### **Mechanical Data**

- Case: JEDEC DO-15 molded plastic body
- Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.014 ounce, 0.40 grams

### Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

| Characteristic   | Symbol            | SF21G         | SF22G | SF23G | SF24G | SF25G | SF26G | SF28G | Units |
|--|-------------------|---------------|-------|-------|-------|-------|-------|-------|-------|
| Maximum repetitive peak reverse voltage  | $V_{RRM}$         | 50            | 100   | 150   | 200   | 300   | 400   | 600   | V     |
| Maximum RMS voltage  | V <sub>RMS</sub>  | 35            | 70    | 105   | 140   | 210   | 280   | 420   | V     |
| Maximum DC blocking voltage  | V <sub>DC</sub>   | 50            | 100   | 150   | 200   | 300   | 400   | 600   | V     |
| Maximum average forward rectified current 0.375"(9.5mm) lead length at $T_A$ =55°C                   | I <sub>(AV)</sub> | 2.0           |       |       | Α     |       |       |       |       |
| Peak forward surge current 8.3ms single half sinewave superimposed on rated load (JEDEC Method)      | I <sub>FSM</sub>  | 75            |       |       | А     |       |       |       |       |
| Maximum instantaneous forward voltage at 2.0A  | V <sub>F</sub>    | 0.95 1.25 1.7 |       |       | 1.7   | V     |       |       |       |
| Maximum DC reverse current T <sub>A</sub> =25 °C at rated DC blocking voltage T <sub>A</sub> =100 °C | I <sub>R</sub>    | 5.0<br>50.0   |       |       | μA    |       |       |       |       |
| Maximum Reverse Recovery Time (Note 1)   | Trr               | 35            |       |       | ns    |       |       |       |       |
| Typical Junction Capacitance (Note 2)  | Сл                | 60.0 30.0     |       |       | pF    |       |       |       |       |
| Typical Thermal Resistance (Note 3)  | R <sub>0JA</sub>  | 50.0          |       |       | °C/W  |       |       |       |       |
| Junction Temperature   | TJ                | -65 to +175   |       |       | °C    |       |       |       |       |
| Storage Temperature Range  | T <sub>STG</sub>  | -65 to +175   |       | °C    |       |       |       |       |       |

Note: 1. Reverse recovery condition IF=0.5A, IR=1.0A. Irr=0.25A

- 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
- 3. Thermal resistance from junction to ambient at 0.375"(9.5mm) lead length, P.C.B mounted.
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    - http://www.smc-diodes.com
       sales@ smc-diodes.com







## **Ratings and Characteristics Curves**

FIG. 1- FORWARD CURRENT DERATING CURVE

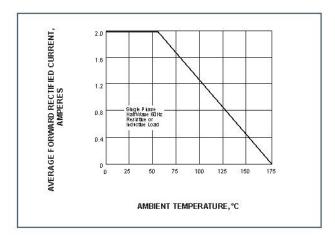


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

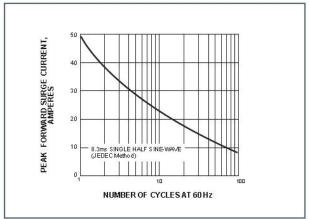


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

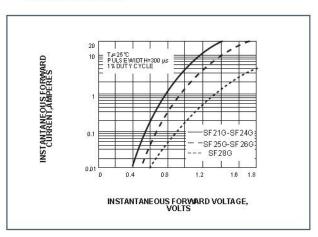


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

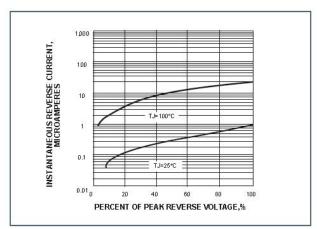
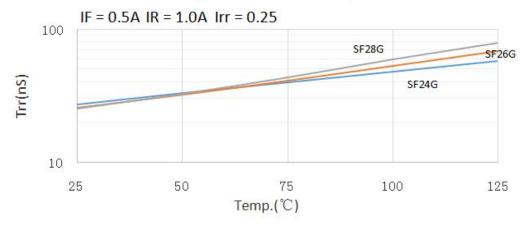


Fig.5 Trr & Temp.



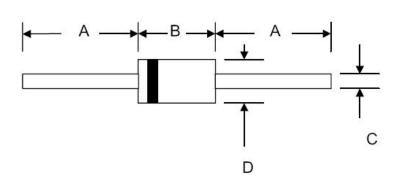
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#### **Mechanical Dimensions DO-15**



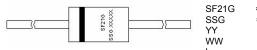
| CVMDOL | Millim | neters | Inches |       |  |  |
|--------|--------|--------|--------|-------|--|--|
| SYMBOL | Min.   | Max.   | Min.   | Max.  |  |  |
| А      | 25.4   | -      | 1.000  | -     |  |  |
| В      | 5.5    | 7.62   | 0.217  | 0.300 |  |  |
| С      | 0.7    | 0.9    | 0.028  | 0.034 |  |  |
| D      | 2.6    | 3.6    | 0.104  | 0.140 |  |  |

## **Ordering Information**

| Device | Package         | Shipping      |  |  |
|--------|-----------------|---------------|--|--|
| SF21G  |                 |               |  |  |
| THRU   | DO-15 (Pb-Free) | 3000pcs /tape |  |  |
| SF28G  |                 |               |  |  |

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Marking Diagram**



Where XXXXX is YYWWL

 SF21G
 = Part Name

 SSG
 = SSG

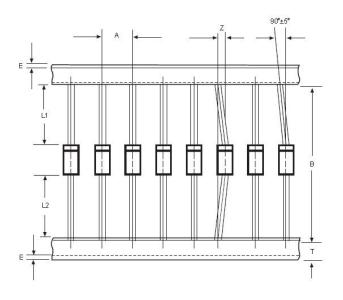
 YY
 = Year

 WW
 = Week

 L
 = Lot Number

**Cautions:** Molding resin Epoxy resin UL:94V-0

# **Carrier Tape Specification DO-15**



| SYMBOL  | Millimeters |      |  |  |
|---------|-------------|------|--|--|
| STWIBOL | Min.        | Max. |  |  |
| А       | 4.50        | 5.50 |  |  |
| В       | 50.9        | 53.9 |  |  |
| Z       | -           | 1.20 |  |  |
| Т       | 5.60        | 6.40 |  |  |
| E       | -           | 0.80 |  |  |
| IL1-L2I | -           | 1.0  |  |  |

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